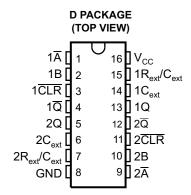
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FEATURES

- Controlled Baseline
 - One Assembly Site
 - One Test Site
 - One Fabrication Site
- Extended Temperature Performance of -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Operating Range 2-V to 5.5-V V_{CC}
- Schmitt-Trigger Circuitry On A, B, and CLR Inputs for Slow Input Transition Rates
- Edge Triggered From Active-High or Active-Low Gated Logic Inputs
- Retriggerable for Long Output Pulses
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- Overriding Clear Terminates Output Pulse
- Glitch-Free Power-Up Reset On Outputs
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



DESCRIPTION/ORDERING INFORMATION

The SN74AHC123A device is a dual retriggerable monostable multivibrator designed for 2-V to 5.5-V V_{CC} operation.

This edge-triggered multivibrator features output pulse-duration control by three methods. In the first method, the \overline{A} input is low, and the \overline{A} input goes high. In the second method, the \overline{A} input is high, and the \overline{A} input goes low. In the third method, the \overline{A} input is low, the B input is high, and the clear (\overline{CLR}) input goes high.

The output pulse duration is programmed by selecting external resistance and capacitance values. The external timing capacitor must be connected between C_{ext} and R_{ext}/C_{ext} (positive) and an external resistor connected between R_{ext}/C_{ext} and V_{CC} . To obtain variable pulse durations, connect an external variable resistance between R_{ext}/C_{ext} and V_{CC} . The output pulse duration can be reduced by taking \overline{CLR} low.

Pulse triggering occurs at a particular voltage level and is not directly related to the transition time of the input pulse. The \overline{A} , \overline{B} , and \overline{CLR} inputs have Schmitt triggers with sufficient hysteresis to handle slow input transition rates with jitter-free triggering at the outputs.

Once triggered, the basic pulse duration can be extended by retriggering the gated low-level-active (\overline{A}) or high-level-active (B) input. Pulse duration can be reduced by taking \overline{CLR} low. \overline{CLR} can be used to override \overline{A} or B inputs. The input/output timing diagram illustrates pulse control by retriggering the inputs and early clearing.

The variance in output pulse duration from device to device is less than $\pm 0.5\%$ (typ) for given external timing components. An example of this distribution for the SN74AHC123A is shown in Figure 10. Variations in output pulse duration versus supply voltage and temperature are shown in Figure 6.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

During power up, Q outputs are in the low state and \overline{Q} outputs are in the high state. The outputs are glitch free, without applying a reset pulse.

For additional application information on multivibrators, see the application report *Designing With the SN74AHC123A and SN74AHCT123A*, literature number SCLA014.

ORDERING INFORMATION(1)

T _A	PACKAGE ⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
–55°C to 125°C	SOIC - D	Tape and reel	SN74AHC123AMDREP	AHC123A-EP	

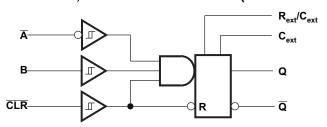
- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI Web site at www.ti.com.
- (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (each multivibrator)

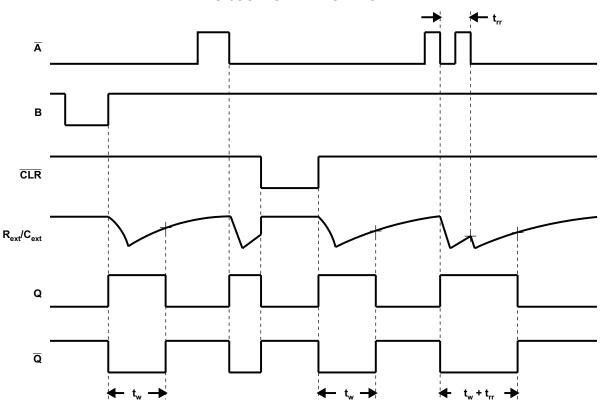
	INPUTS		OUTPUTS			
CLR	Ā	В	Q	Q		
L	Х	Х	L	Н		
X	Н	X	L ⁽¹⁾	H ⁽¹⁾		
X	Χ	L	L ⁽¹⁾	H ⁽¹⁾		
Н	L	1	Л	Т		
Н	\downarrow	Н	Л	П		
1	L	Н	Л	П		

(1) These outputs are based on the assumption that the indicated steady-state conditions at the A and B inputs have been set up long enough to complete any pulse started before the setup.

LOGIC DIAGRAM, EACH MULTIVIBRATOR (POSITIVE LOGIC)



INPUT/OUTPUT TIMING DIAGRAM



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range ⁽²⁾		-0.5	7	V
VI	Input voltage range (3)		-0.5	7	V
Vo	Output voltage range in high or low sta	ate ⁽²⁾	-0.5	V _{CC} + 0.5	V
Vo	Output voltage range in power-off state	e ⁽²⁾	-0.5	7	V
I _{IK}	Input clamp current	V _I < 0 V		-20	mA
I _{OK}	Output clamp current	$V_O < 0 \text{ V or } V_O < V_{CC}$		±20	mA
Io	Continuous output current	$V_O = 0 \text{ V to } V_{CC}$		±25	mA
	Continuous current through V _{CC} or GN	ID		±50	mA
θ_{JA}	Package thermal impedance (4)			73	°C/W
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ Voltage values are with respect to the network ground terminal.

⁽³⁾ The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.

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Recommended Operating Conditions⁽¹⁾

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2	5.5	V
		V _{CC} = 2 V	1.5		
V_{IH}	High-level input voltage	V _{CC} = 3 V	2.1		V
		V _{CC} = 5.5 V	3.85		
		V _{CC} = 2 V		0.5	
V_{IL}	Low-level input voltage	V _{CC} = 3 V		0.9	V
			1.65		
VI	Input voltage		0	5.5	V
Vo	Output voltage		0	V_{CC}	V
		V _{CC} = 2 V		-50	μΑ
I_{OH}	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	mΛ
		$V_{CC} = 5 V \pm 0.5 V$		-8	mA
		V _{CC} = 2 V		50	μΑ
I_{OL}	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4	A
		$V_{CC} = 5 V \pm 0.5 V$		8	mA
В	External timing registeres	V _{CC} = 2 V	5		kΩ
R _{ext}	External timing resistance	V _{CC} > 3 V	1		K12
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		1		ms/V
T _A	Operating free-air temperature		-55	125	°C

⁽¹⁾ Unused R_{ext}/C_{ext} terminals should be left unconnected. All remaining unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. See the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

	DADAMETED	TEST CONDITIONS	V	T,	₄ = 25°C		MIN MAX	LINUT		
	PARAMETER	TEST CONDITIONS	V _{CC}	MIN	TYP	MAX	IVIIN	WAX	UNIT	
			2 V	1.9	2		1.9			
		$I_{OH} = -50 \mu A$	3 V	2.9	3		2.9			
V_{OH}			4.5 V	4.4	4.5		4.4		V	
		$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48			
		$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8			
			2 V			0.1		0.1		
		$I_{OL} = 50 \mu A$	3 V			0.1		0.1	V	
V_{OL}			4.5 V			0.1		0.1		
		I _{OL} = 4 mA	3 V			0.36		0.44		
		$I_{OL} = 8 \text{ mA}$	4.5 V			0.36		0.44		
	R _{ext} /C _{ext} ⁽¹⁾	$V_I = V_{CC}$ or GND	5.5 V			±0.25		±2.5	^	
I _I	A, B, and CLR	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1		±1 (2)	μΑ	
I _{CC}	Quiescent	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40	μΑ	
			3 V		160	250		280		
I_{CC}	Active state (per circuit)	$V_I = V_{CC}$ or GND, $R_{ext}/C_{ext} = 0.5 V_{CC}$	4.5 V		280	500		650	μΑ	
	(por oriodit)	rext/ Cext - 0.5 VCC	5.5 V		360	750		975		
Ci		$V_I = V_{CC}$ or GND	5 V		1.9	10		10	pF	

⁽¹⁾ This test is performed with the terminal in the off-state condition.

⁽²⁾ On products compliant to MIL-PRF-38535, this parameter is not production tested at $V_{CC} = 0 \text{ V}$.

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Timing Requirements

over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

	PARAMETER		TEST CONDITIONS	T	T _A = 25°C		MIN	MAX	UNIT
			TEST CONDITIONS	MIN	TYP	MAX	IVIIIN	IVIAA	ONII
_	Dulas duration	CLR		5			5		20
ı _w	Pulse duration	A or B trigger		5			5		ns
	Dulas ratingger time		$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 100 \text{ pF}$	(1)	76		(1)		ns
r _{rr}	t _{rr} Pulse retirgger time		$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 0.01 \mu\text{F}$	(1)	1.8		(1)		μs

⁽¹⁾ See retriggering data in the application information section.

Timing Requirements

over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

	PARAMETER		TEST CONDITIONS	TA	T _A = 25°C		MIN	MAX	UNIT
			TEST CONDITIONS	MIN	TYP	MAX	IVIIIN	IVIAA	UNIT
	Dulas duration	CLR		5			5		20
ı _w	Pulse duration	A or B trigger		5			5		ns
	t _r . Pulse retirgaer time		$R_{\text{ext}} = 1 \text{ k}\Omega, C_{\text{ext}} = 100 \text{ pF}$	(1)	59		(1)		ns
L _{rr}			$R_{\text{ext}} = 1 \text{ k}\Omega, C_{\text{ext}} = 0.01 \mu\text{F}$	(1)	1.5		(1)		μs

⁽¹⁾ See retriggering data in the application information section.

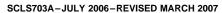
Switching Characteristics

over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	TEST CONDITIONS	T _A	= 25°C	;	MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	IVIIIN	IVIAA	UNII
t _{PLH}	Ā or B	Q or $\overline{\mathbb{Q}}$	C _L = 15 pF		9.5 ⁽¹⁾	20.6(1)	1 ⁽¹⁾	24 ⁽¹⁾	20
t _{PHL}	AUID	QUQ	C _L = 15 pr	1	0.2(1)	20.6(1)	1 ⁽¹⁾	24 ⁽¹⁾	ns
t _{PLH}	CLR	Q or Q	C _L = 15 pF		7.5 ⁽¹⁾	15.8 ⁽¹⁾	1 ⁽¹⁾	18.5 ⁽¹⁾	ns
t _{PHL}	CLK	Q 01 Q	O _L = 13 pr		9.3 ⁽¹⁾	15.8 ⁽¹⁾	1 ⁽¹⁾	18.5 ⁽¹⁾	10
t _{PLH}	CLR trigger	Q or $\overline{\mathbb{Q}}$	C - 15 pF		10 ⁽¹⁾	22.4(1)	1 ⁽¹⁾	26 ⁽¹⁾	ns
t _{PHL}	CLN trigger	Q 01 Q	or \overline{Q} $C_L = 15 \text{ pF}$		0.6 ⁽¹⁾	22.4(1)	1 ⁽¹⁾	26 ⁽¹⁾	10
t _{PLH}	Ā or B	Q or $\overline{\mathbb{Q}}$	C _L = 50 pF		10.5	24.1	1	27.5	ne
t _{PHL}	AUB	Q 01 Q	O _L = 30 pr		11.8	24.1	1	27.5	ns 5
t _{PLH}	CLR	Q or $\overline{\mathbb{Q}}$	C _L = 50 pF		8.9	19.3	1	22	ns
t _{PHL}	CLIX	α οι α οι = 30 βι			10.5	19.3	1	22	115
t _{PLH}	CLR trigger	_R trigger Q or Q	C _L = 50 pF		11	25.9	1	29.5	ns
t _{PHL}	CLIV trigger	Q 01 Q	О_ = 30 рі		12.3	25.9	1	29.5	115
			C_L = 50 pF, C_{ext} = 28 μ F, R_{ext} = 2 k Ω		182	240		300	ns
t _w (2)		Q or $\overline{\mathbb{Q}}$	C_L = 50 pF, C_{ext} = 0.01 μ F, R_{ext} = 10 k Ω	90	100	110	90	110	μs
			C_L = 50 pF, C_{ext} = 0.1 μ F, R_{ext} = 10 $k\Omega$	0.9	1	1.1	0.9	1.1	ms
$\Delta t_w^{(3)}$					±1%				

⁽¹⁾ On products compliant to MIL_PRF-38535, this parameter is not production tested.

 ⁽²⁾ t_w = Pulse duration at Q and Q outputs
 (3) Δt_w = Output pulse-duration variation (Q and Q) between circuits in same package





Switching Characteristics

over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	TEST CONDITIONS	T,	չ = 25°0	;	MIN	MAX	LINUT
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	IVIIIN	WAA	UNIT
t _{PLH}	Ā or B	Q or $\overline{\mathbb{Q}}$	C _L = 15 pF		6.5 ⁽¹⁾	12 ⁽¹⁾	1 (1)	14 ⁽¹⁾	ns
t _{PHL}	AUID	QUIQ	C _L = 15 pr		7.1 (1)	12 ⁽¹⁾	1 (1)	14 ⁽¹⁾	115
t _{PLH}	CLR	Q or $\overline{\mathbb{Q}}$	C _L = 15 pF		5.3 ⁽¹⁾	9.4 ⁽¹⁾	1 ⁽¹⁾	11 ⁽¹⁾	ns
t _{PHL}	CLK	QuiQ	OL = 13 pr		6.5 ⁽¹⁾	9.4(1)	1 ⁽¹⁾	11 ⁽¹⁾	10
t _{PLH}	CLR trigger	Q or $\overline{\mathbb{Q}}$	C - 15 pE		6.9 ⁽¹⁾	12.9 ⁽¹⁾	1 ⁽¹⁾	15 ⁽¹⁾	no
t _{PHL}	CLK trigger	QUIQ	or \overline{Q} $C_L = 15 \text{ pF}$		7.4(1)	12.9 ⁽¹⁾	1 (1)	15 ⁽¹⁾	ns
t _{PLH}	Ā or B	0.55	C _ 50 %E		7.3	14	1	16	20
t _{PHL}	AUID	Q or \overline{Q}	$C_L = 50 \text{ pF}$		8.3	14	1	16	ns
t _{PLH}	<u>CLR</u>	O or \overline{O}	Q or \overline{Q} $C_L = 50 \text{ pF}$		6.3	11.4	1	13	ns
t _{PHL}	CLK	QOIQ			7.4	11.4	1	13	113
t _{PLH}	CLR trigger	Q or Q	C _L = 50 pF		7.6	14.9	1	17	20
t _{PHL}	CLK trigger	QUIQ	C _L = 50 pr		8.7	14.9	1	17	ns
			C_L = 50 pF, C_{ext} = 28 μ F, R_{ext} = 2 k Ω		167	200		240	ns
t _w (2)		Q or $\overline{\mathbb{Q}}$	C_L = 50 pF, C_{ext} = 0.01 μ F, R_{ext} = 10 k Ω	90	100	110	90	110	μs
			C_L = 50 pF, C_{ext} = 0.1 μ F, R_{ext} = 10 k Ω	0.9	1	1.1	0.9	1.1	ms
$\Delta t_w^{(3)}$					±1%				

⁽¹⁾ On products compliant to MIL-PRF-38535, this parameter is not production tested.

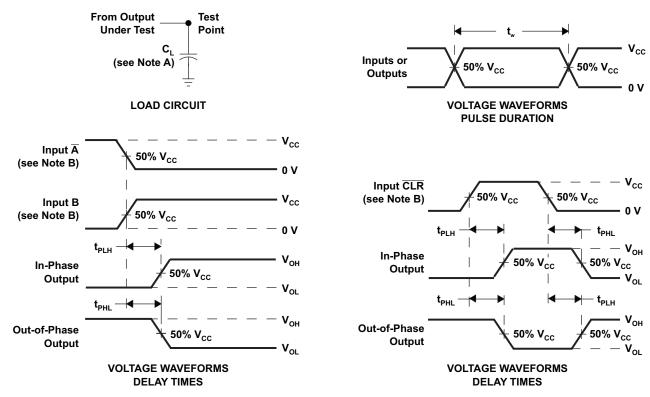
Operating Characteristics

 $V_{CC} = 5 \text{ V}, T_{A} = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance	No load	29	pF

 ⁽²⁾ t_w = Pulse duration at Q and Q outputs
 (3) Δt_w = Output pulse-duration variation (Q and Q) between circuits in same package

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: $Z_{\Omega} = 50 \Omega$, $t_r = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- C. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



APPLICATION INFORMATION

Caution in Use

To prevent malfunctions due to noise, connect a high-frequency capacitor between V_{CC} and GND, and keep the wiring between the external components and C_{ext} and R_{ext}/C_{ext} terminals as short as possible.

Powerdown Considerations

Large values of C_{ext} can cause problems when powering down the SN74AHC123A devices because of the amount of energy stored in the capacitor. When a system containing this device is powered down, the capacitor can discharge from V_{CC} through the protection diodes at pin 2 or pin 14. Current through the input protection diodes must be limited to 30 mA; therefore, the turn-off time of the V_{CC} power supply must not be faster than $t = V_{CC} \times C_{ext}/30$ mA. For example, if $V_{CC} = 5$ V and $C_{ext} = 15$ pF, the V_{CC} supply must turn off no faster than $t = (5 \text{ V}) \times (15 \text{ pF})/30$ mA = 2.5 ns. Usually, this is not a problem because power supplies are heavily filtered and cannot discharge at this rate. When a more rapid decrease of V_{CC} to zero occurs, the SN74AHC123A can sustain damage. To avoid this possibility, use external clamping diodes.

Output Pulse Duration

The output pulse duration (t_w) is determined primarily by the values of the external capacitance (C_T) and timing resistance (R_T) . The timing components are connected as shown in Figure 2.

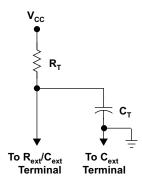


Figure 2. Timing-Component Connections

The pulse duration is given by:

$$t_{w} = K \times R_{T} \times C_{T} \tag{1}$$

if C_T is ≥ 1000 pF, K = 1 or

if C_T is < 1000 pF, K can be determined from Figure 9

where:

t_w = pulse duration in ns

 R_T = external timing resistance in $k\Omega$

C_T = external capacitance in pF

K = multiplier factor

Equation 1 and Figure 3 can be used to determine values for pulse duration, external resistance, and external capacitance.

APPLICATION INFORMATION (continued)

Retriggering Data

NOTE: Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

The minimum input retriggering time (t_{MIR}) is the minimum time required after the initial signal before retriggering the input. After t_{MIR} , the device retriggers the output. Experimentally, it also can be shown that to retrigger the output pulse, the two adjacent input signals should be t_{MIR} apart, where $t_{MIR} = 0.3 \times t_{w}$. The retrigger pulse duration is calculated as shown in Figure 3.

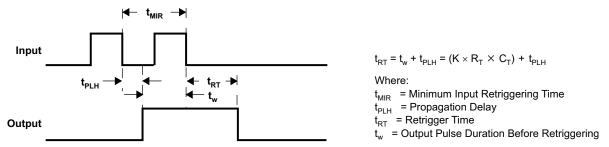
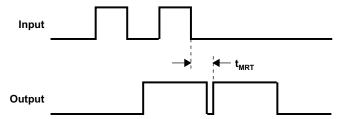


Figure 3. Retrigger Pulse Duration

The minimum value from the end of the input pulse to the beginning of the retriggered output should be approximately 15 ns to ensure a retriggered output (see Figure 4).



 t_{MRT} = Minimum Time Between the End of the Second Input Pulse and the Beginning of the Retriggered Output t_{MRT} = 15 ns

Figure 4. Input/Output Requirements



APPLICATION INFORMATION (continued)

NOTE: Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

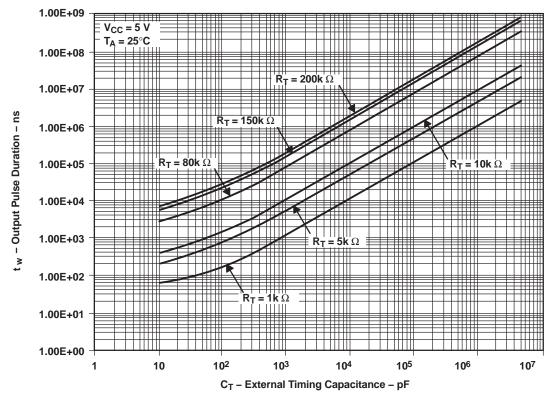


Figure 5. Output Pulse Duration vs External Timing Capacitance

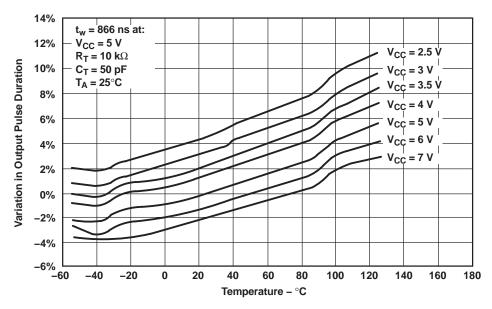
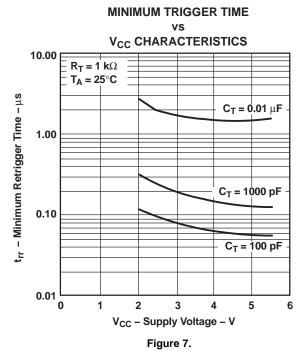


Figure 6. Variations in Output Pulse Duration vs Temperature

APPLICATION INFORMATION (continued)

NOTE: Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



EXTERNAL CAPACITANCE VALUE

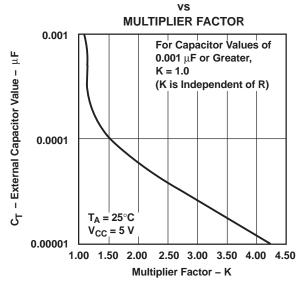


Figure 9.

OUTPUT PULSE-DURATION CONSTANT vs SUPPLY VOLTAGE

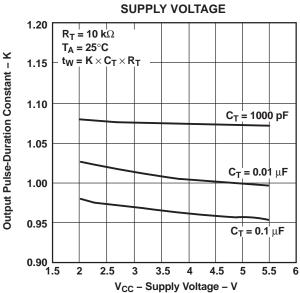


Figure 8.

DISTRIBUTION OF UNITS vs

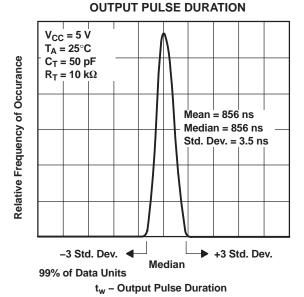


Figure 10.

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
SN74AHC123AMDREP	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC123AEP
SN74AHC123AMDREP.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC123AEP
SN74AHC123AMDREPG4	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC123AEP
V62/06665-01XE	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC123AEP

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN74AHC123A-EP:

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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● Catalog : SN74AHC123A

Military : SN54AHC123A

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

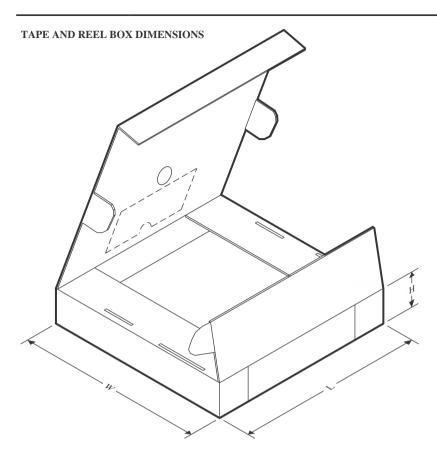
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	U	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AHC123AMDREP	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

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*All dimensions are nominal

Device		Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	SN74AHC123AMDREP	SOIC	D	16	2500	353.0	353.0	32.0	

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



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